



IFW

**PATENT APPLICATION**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Makoto UEKI, et al.

Docket No: Q88465

Appln. No.: 10/538,306

Group Art Unit: 2811

Confirmation No.: 3461

Examiner: Ajay ARORA

Filed: June 9, 2005

For: COPPER ALLOY FOR WIRING, SEMICONDUCTOR DEVICE, METHOD FOR FORMING WIRING AND METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICE

**RESPONSE TO RESTRICTION REQUIREMENT**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

This responds to the Restriction Requirement, dated September 7, 2006. In response to the Restriction Requirement, Applicant elects Group II, claims 17-25 for examination. This election is made without traverse.

Applicant reserves the right to file a Divisional Application directed to non-elected claims 7-16.

Prompt and favorable action on the elected claims is now respectfully requested.

Respectfully submitted,

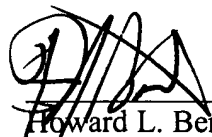
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WASHINGTON OFFICE

**23373**

CUSTOMER NUMBER

Date: September 28, 2006

  
Howard L. Bernstein  
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